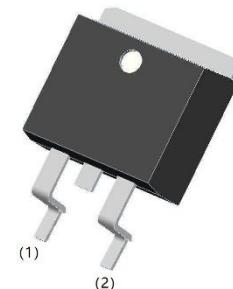


**V<sub>RRM</sub>** = 650 V

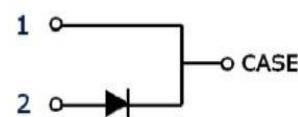
**I<sub>F</sub>(T<sub>c</sub>=150°C)** = 6.3 A

**Q<sub>C</sub>** = 19 nC



### Features:

- Extremely low reverse current
- No reverse recovery current
- Temperature independent switching
- Positive temperature coefficient on V<sub>F</sub>
- Excellent surge current capability
- Low capacitive charge



### Benefits

- Essentially No switching losses
- System efficiency improvement over Si Diodes
- Increased power density
- Enabling higher switching frequency
- Reduction of Heat Sink Requirements
- System cost savings due to smaller magnetics
- Reduced EMI



### Applications

- Switch Mode Power Supplies (SMPS)
- Uninterruptable Power Supplies
- Motor Drivers
- Power Factor Correction

### Package Pin definitions

- Pin1-Cathode
- Pin2-Anode

### Package Parameters

Part Number	Marking	Package
B1D06065F	B1D06065F	TO-263-2

**Maximum ratings**

Symbol	Parameter	Test conditions	Value	Unit
$V_{RRM}$	Repetitive Peak Reverse Voltage		650	V
$V_{RSM}$	Surge Peak Reverse Voltage		650	V
$I_F$	Continuous Forward Current	$T_c=25^\circ C$ $T_c=135^\circ C$ $T_c=150^\circ C$	18 8.4 6.3	A
$I_{FSM}$	Non-Repetitive Forward Surge Current	$T_c=25^\circ C, t_p=10ms$ , sine halfwave	42	A
$\int i^2 dt$	$i^2 t$ Value	$T_c=25^\circ C, t_p=10ms$	8.82	A <sup>2</sup> S
$P_{tot}$	Power Dissipation	$T_c=25^\circ C$ $T_c=110^\circ C$	90 38	W
$T_j$	Operating junction temperature		-55~175	°C
$T_{stg}$	Storage temperature		-55~135	°C

**Thermal Characteristics**

Symbol	Parameter	Value			Unit
		Min.	Typ.	Max.	
$R_{th(jc)}$	Thermal resistance from junction to case		1.66		K/W
$R_{th(ja)}$	Thermal resistance from junction to ambient		69		K/W

**Electrical Characteristics****Static Characteristics (T<sub>j</sub>=25°C unless otherwise specified)**

<b>Symbol</b>	<b>Parameter</b>	<b>Test conditions</b>	<b>Value</b>			<b>Unit</b>
			<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	
V <sub>DC</sub>	DC blocking voltage	T <sub>j</sub> =25°C	650			V
V <sub>F</sub>	Diode forward voltage	I <sub>F</sub> =6A T <sub>j</sub> =25°C I <sub>F</sub> =6A T <sub>j</sub> =175°C		1.45 1.9		V
I <sub>R</sub>	Reverse current	V <sub>R</sub> =650V T <sub>j</sub> =25°C V <sub>R</sub> =650V T <sub>j</sub> =175°C		0.05 3		μA

**Dynamic Characteristics (T<sub>j</sub>=25°C unless otherwise specified)**

<b>Symbol</b>	<b>Parameter</b>	<b>Test conditions</b>	<b>Value</b>			<b>Unit</b>
			<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	
Q <sub>C</sub>	Total capacitive charge	V <sub>R</sub> =400V T <sub>j</sub> =25°C $Q_C = \int_0^{V_R} C(V)dV$		19		nC
C	Total Capacitance	V <sub>R</sub> =1V f=1MHz V <sub>R</sub> =300V f=1MHz V <sub>R</sub> =600V f=1MHz		290 33.7 33		pF

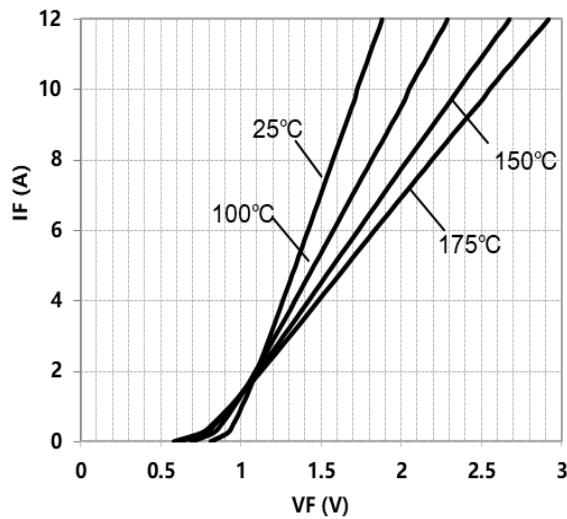


Figure 1. Typical forward characteristics

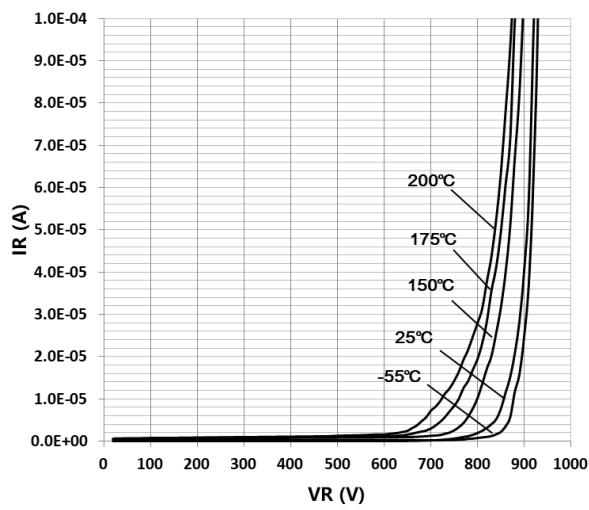


Figure 2. Typical reverse current as function of reverse voltage

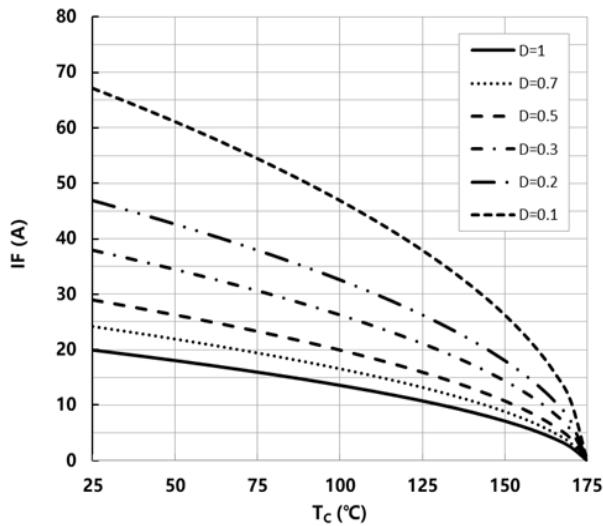


Figure 3. Diode forward current as function of temperature, D=duty cycle

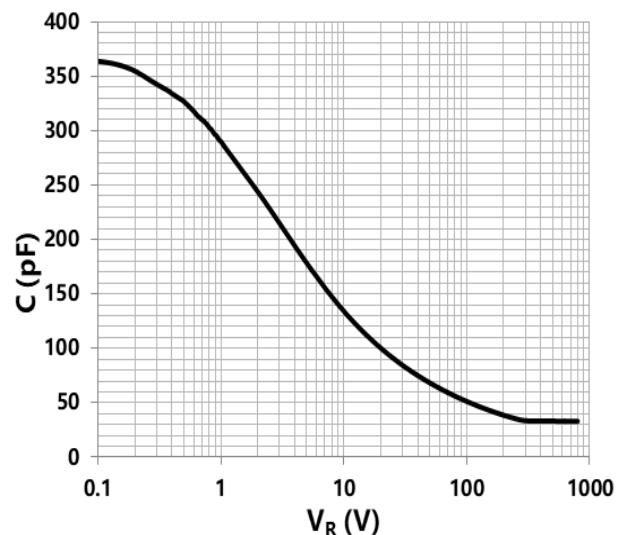


Figure 4. Typical capacitance as function of reverse voltage,  $C=f(V_R)$ ;  $T_j=25^\circ\text{C}$ ;  $f=1 \text{ MHz}$

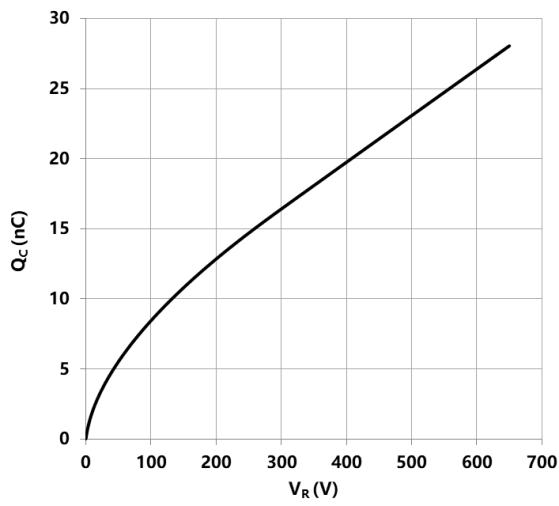


Figure 5. Typical reverse charge as function of reverse voltage

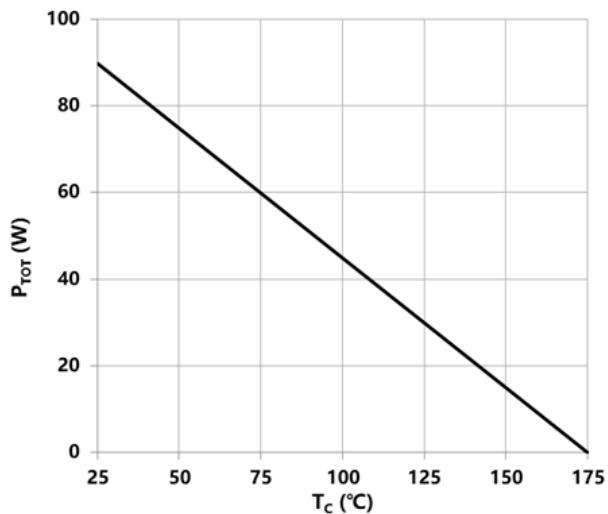


Figure 6. Power dissipation as function of case temperature

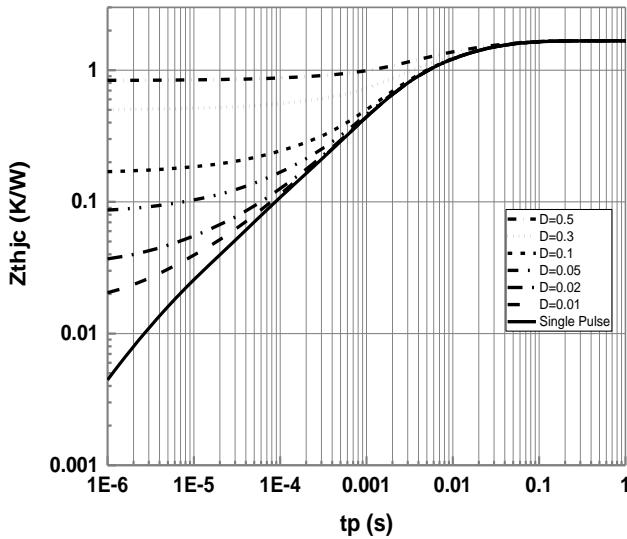
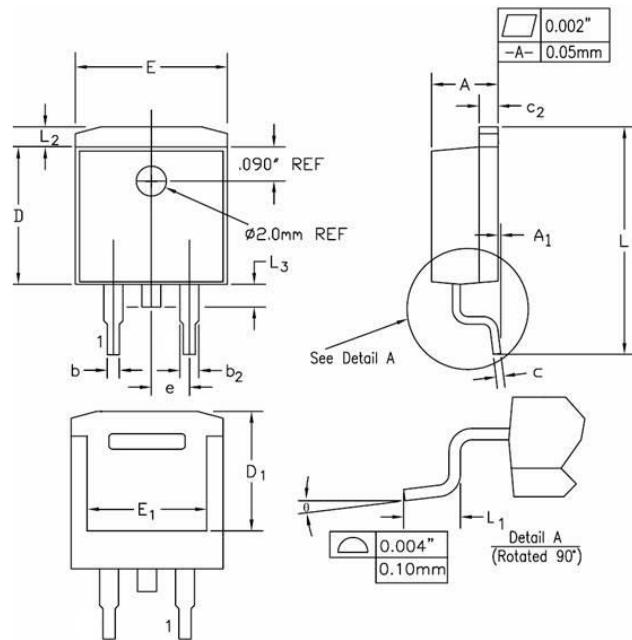


Figure 7. Max. transient thermal impedance,  
 $Z_{th,jc}=f(t)$ , parameter:  $D=t/T$

### Package Dimensions



POS	Inches		Millimeters	
	Min	Max	Min	Max
A	0.17	0.18	4.32	4.57
A1	-	0.01	-	0.25
b	0.028	0.037	0.71	0.94
b2	0.045	0.055	1.15	1.4
c	0.014	0.025	0.356	0.635
c2	0.048	0.055	1.22	1.4
D	0.35	0.37	8.89	9.4
D1	0.255	0.324	6.48	8.23
E	0.395	0.405	10.04	10.28
E1	0.31	0.318	7.88	8.08
e	0.1	BSC.	2.54	BSC.
L	0.58	0.62	14.73	15.75
L1	0.09	0.11	2.29	2.79
L2	0.045	0.055	1.15	1.39
L3	0.05	0.07	1.27	1.77
θ	0°	8°	0°	8°

**Revision History:**

**Preliminary Version**

**Previous Revision:**

**BASiC Semiconductor Ltd.**  
**Shenzhen, China**  
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